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\*\* CONTINUING DATA \*\*\*\*\* NEW

\*\* FOREIGN APPLICATIONS \*\*\*\*\* NONE

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY TAIWAN	SHEETS DRAWING 3	TOTAL CLAIMS 38	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature	Initials		

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## TITLE

Surface treated low-k dielectric as diffusion barrier for copper metallization

☐ All Fees